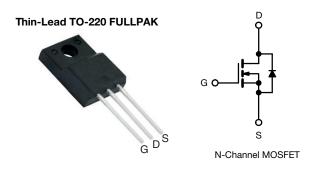
## SiHA12N50E

**Vishay Siliconix** 



## **E Series Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	550			
R <sub>DS(on)</sub> max. (Ω) at 25 °C	V <sub>GS</sub> = 10 V 0.380			
Q <sub>g</sub> max. (nC)	50			
Q <sub>gs</sub> (nC)	6			
Q <sub>gd</sub> (nC)	10			
Configuration	Single			

#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Computing
  - PC silver box / ATX power supplies
- Lighting
  - Two stage LED lighting
- Consumer electronics
- · Applications using hard switched topologies
  - Power factor correction (PFC)
  - Two switch forward converter
  - Flyback converter
- Switch mode power supplies (SMPS)

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free	SiHA12N50E-E3			
Lead (Pb)-free and halogen-free	SiHA12N50E-GE3			

ABSOLUTE MAXIMUM RATINGS ( $T_C$	= 25 °C, unl	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	500	v	
Gate-source voltage			V <sub>GS</sub>	± 30	v	
Continuous drain surrant (T 150 °C) f	V at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I <sub>D</sub>	10.5		
Continuous drain current ( $T_J = 150 \ ^\circ C$ ) $^e$	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		6.6	A	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	21		
Linear derating factor				0.91	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	103	mJ	
Maximum power dissipation			P <sub>D</sub>	32	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	$V_{DS} = 0 V \text{ to } 80 \% V_{DS}$		al) / / alt	70		
Reverse diode dV/dt <sup>d</sup>			dV/dt	27	V/ns	
Soldering recommendations (peak temperature) <sup>c</sup>	for 10 s			300	°C	
Mounting torque	M3 screw			0.6	Nm	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 28.2 mH,  $R_a = 25 \Omega$ ,  $I_{AS} = 2.7$  A
- c. 1.6 mm from case
- d.  $I_{SD} \leq I_D$ , dI/dt = 100 A/µs, starting T<sub>J</sub> = 25 °C
- e. Limited by maximum junction temperature

RoHS COMPLIANT HALOGEN

FREE



Vishay Siliconix

PARAMETER	SYMBOL	TYP.	MAX	MAX.		UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	-	65	65 3.9				
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	3.9			°C/W		
SPECIFICATIONS (T <sub>J</sub> = 25 °C, u	nless otherwi	ise noted)						
PARAMETER	SYMBOL	1	CONDITIONS	MIN.	TYP.	MAX.	UNI	
Static	OTINDOL	120			_ · · · ·	100-033	UNI	
Drain-source breakdown voltage	V <sub>DS</sub>	Vcs	= 0 V, I <sub>D</sub> = 250 μA	500	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	<u>ao</u>	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.60	-	V/°(	
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	-	· V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V	
	• GS(III)		$V_{GS} = \pm 20 V$	-	_	± 100	nA	
Gate-source leakage	I <sub>GSS</sub>	$V_{GS} = \pm 30 \text{ V}$		-	-	± 1	μA	
			$V_{GS} = \pm 30 \text{ V}$ $V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V}$		_	1	P**	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = 300 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$		-	-	10	μA	
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{DS} = 400 V, V_{GS} = 0 V, I_{J} = 125 V$ $V_{GS} = 10 V$ $I_{D} = 6 A$		-	0.330	0.380	Ω	
Forward transconductance	gfs		$= 30 \text{ V}, \text{ I}_{\text{D}} = 6 \text{ A}$	-	3.1	-	S	
Dynamic	313					ļ		
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	886	-	-	
Output capacitance	C <sub>oss</sub>			-	52	-		
Reverse transfer capacitance	C <sub>rss</sub>			-	6	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	- V <sub>DS</sub> = 0 V to 400 V, V <sub>GS</sub> = 0 V		-	45	-	pF	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	131	-		
Total gate charge	Qg		$V_{GS} = 10 \text{ V}$ $I_D = 6 \text{ A}, \text{ V}_{DS} = 400 \text{ V}$		25	50	nC	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 V$			6	-		
Gate-drain charge	Q <sub>gd</sub>				10	-		
Turn-on delay time	t <sub>d(on)</sub>			-	13	26		
Rise time	t <sub>r</sub>	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 6 \text{ A}, \\ V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	16	32		
Turn-off delay time	t <sub>d(off)</sub>			-	29	58	- ns	
Fall time	t <sub>f</sub>			-	12	24		
Gate input resistance	Rg	f = 1 MHz, open drain		-	0.92	-	Ω	
Drain-Source Body Diode Characteristic	s				-			
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	10.5		
Pulsed diode forward current	I <sub>SM</sub>			-	-	21	1 A	
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 7.5 A, V <sub>GS</sub> = 0 V		-	-	1.2	V	
Reverse recovery time	t <sub>rr</sub>			-	244	-	ns	
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, $I_F = I_S = 6 A$ , dl/dt = 100 A/µs, $V_R = 25 V$		-	2.5	-	μΟ	
Reverse recovery current	I <sub>RRM</sub>			-	19	-	A	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



## SiHA12N50E

**Vishay Siliconix** 

### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

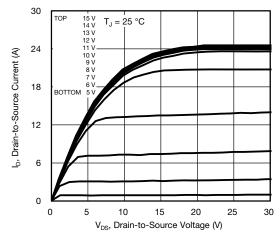


Fig. 1 - Typical Output Characteristics

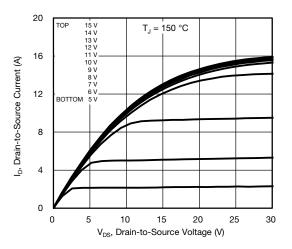


Fig. 2 - Typical Output Characteristics

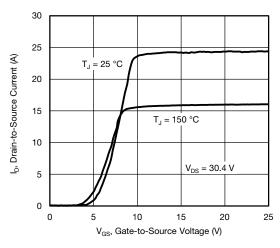


Fig. 3 - Typical Transfer Characteristics

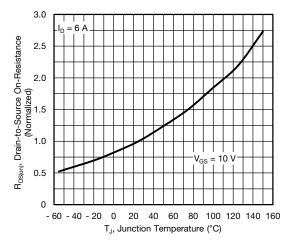


Fig. 4 - Normalized On-Resistance vs. Temperature

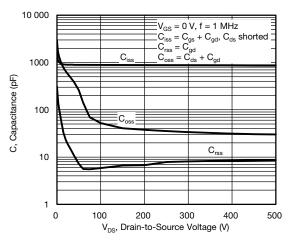


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

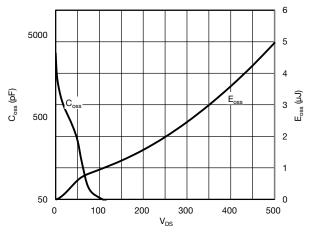


Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$ 

For technical questions, contact: <u>hvm@vishay.com</u>
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT
ARE SUBJECT TO SPECIFI
Downloaded From Oneyac.com
w.vishay.com/doc?91000



SiHA12N50E

**Vishay Siliconix** 

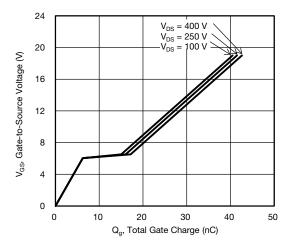


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

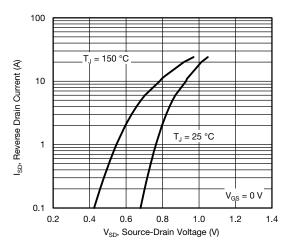


Fig. 8 - Typical Source-Drain Diode Forward Voltage

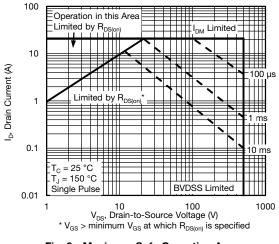


Fig. 9 - Maximum Safe Operating Area

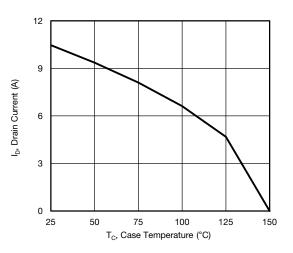


Fig. 10 - Maximum Drain Current vs. Case Temperature

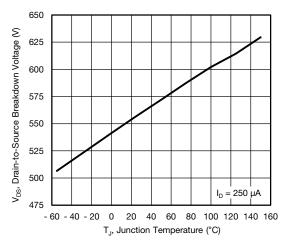
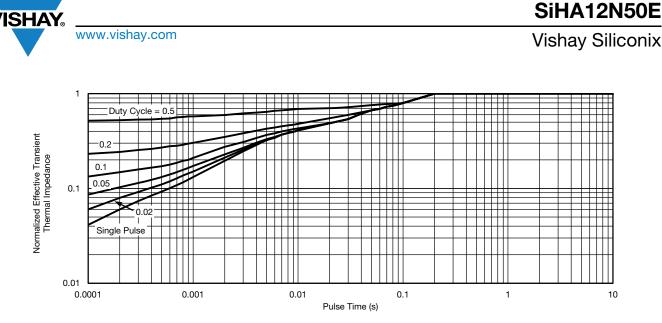


Fig. 11 - Temperature vs. Drain-to-Source Voltage

4





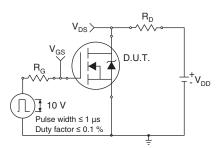


Fig. 13 - Switching Time Test Circuit

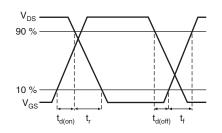


Fig. 14 - Switching Time Waveforms

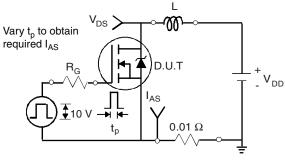


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 16 - Unclamped Inductive Waveforms

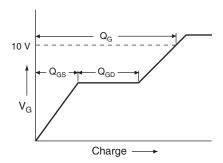


Fig. 17 - Basic Gate Charge Waveform

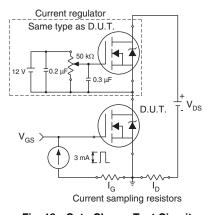
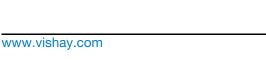


Fig. 18 - Gate Charge Test Circuit

Document Number: 91637



SHAY

### Vishay Siliconix

#### Peak Diode Recovery dV/dt Test Circuit

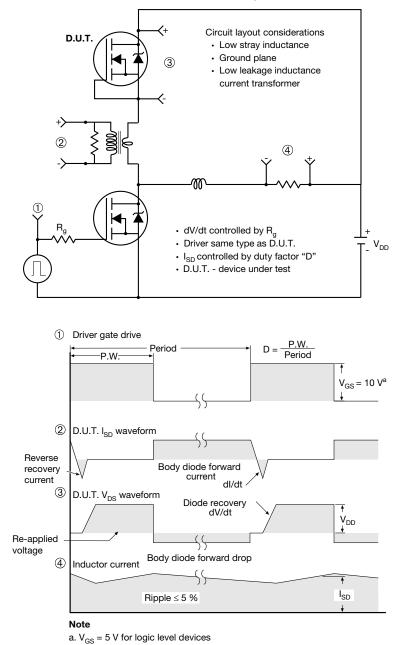


Fig. 19 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?91637">www.vishay.com/ppg?91637</a>.

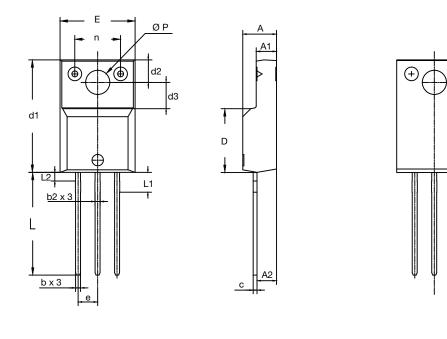
Document Number: 91637

 $\oplus$ 



Vishay Siliconix

# **TO-220 FULLPAK Thin Lead**





	DIMENSIONS						
SYMBOL	MILLIN	IETERS	INCHES				
	MIN.	MAX.	MIN.	MAX.			
А	4.30	4.70	0.169	0.185			
A1	2.50	2.90	0.098	0.114			
A2	2.50	2.70	0.098	0.106			
b	0.60	0.80	0.024	0.031			
b2	0.60	0.90	0.024	0.035			
С	-	0.60	-	0.024			
D	8.30	8.70	0.327	0.342			
d1	14.70	15.30	0.579	0.602			
d2	2.90	3.10	0.114	0.122			
d3	3.40	3.60	0.134	0.142			
E	9.70	10.30	0.382	0.406			
е	2.50	2.70	0.098	0.106			
L	13.40	13.80	0.528	0.543			
L1	2.50	2.80	0.098	0.110			
L2	-	1.20	-	0.047			
n	6.05	6.15	0.238	0.242			
ØP	3.00	3.40	0.118	0.134			

Revision: 12-Sep-16

1



Vishay

## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.



单击下面可查看定价,库存,交付和生命周期等信息

>>Vishay(威世)